

L, S-band High Power SPDT RF Switch

DESCRIPTION

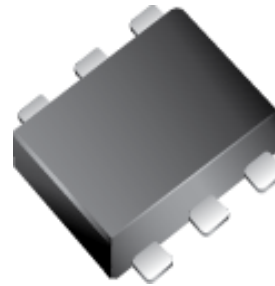
- The CG2415M6 is a pHEMT GaAs MMIC high power SPDT (Single Pole Double Throw) switch which was developed for dual-band wireless LAN.

FEATURES

- Control voltage :
VC(H) = 1.8 to 5.3 V (3.0 V TYP.)
VC(L) = -0.2 to 0.2 V (0 V TYP.)
- Low insertion loss :
L_{ins1} = 0.30 dB TYP. @ f = 0.5 to 2.0 GHz
L_{ins2} = 0.35 dB TYP. @ f = 2.0 to 2.5 GHz
L_{ins3} = 0.40 dB TYP. @ f = 2.5 to 3.8 GHz
L_{ins4} = 0.45 dB TYP. @ f = 3.8 to 6.0 GHz
- High isolation :
ISL1 = 32 dB TYP. @ f = 0.5 to 2.0 GHz
ISL2 = 32 dB TYP. @ f = 2.0 to 2.5 GHz
ISL3 = 32 dB TYP. @ f = 2.5 to 3.8 GHz
ISL4 = 26 dB TYP. @ f = 3.8 to 6.0 GHz
- Power handling :
P_{in(0.5dB)} = +34 dBm TYP
VC(H) = 3.0 V, VC(L) = 0 V

PACKAGE

- 6-pin lead-less mini mold package (1.5mm x 1.1mm x 0.55mm)



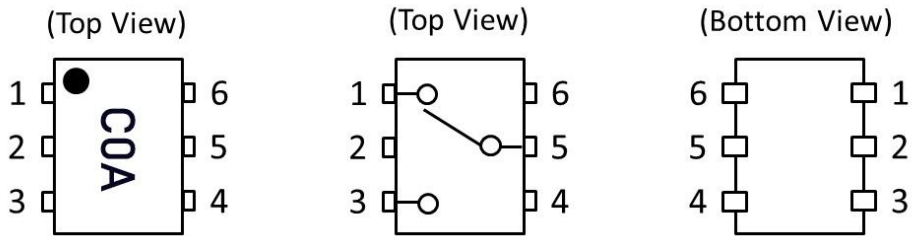
APPLICATIONS

- Dual-band wireless LAN (IEEE 802.11 a/b/g/n/ac)

ORDERING INFORMATION

| Part Number | Order Number | Package | Marking | Description |
|---------------|---------------|---|---------|--|
| CG2415M6 | CG2415M6-C2 | 6-pin lead-less mini mold package (Pb-Free) | C0A | <ul style="list-style-type: none"> Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape MOQ 9 kpcs/reel |
| CG2415M6-EVAL | CG2415M6-EVAL | | | <ul style="list-style-type: none"> Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors MOQ 1 |

PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM



| Pin No. | Pin Name |
|---------|----------|
| 1 | RF1 |
| 2 | GND |
| 3 | RF2 |
| 4 | VC2 |
| 5 | RFC |
| 6 | VC1 |

TRUTH TABLE

| VC1 | VC2 | RFC-RF1 | RFC-RF2 |
|------|------|---------|---------|
| High | Low | ON | OFF |
| Low | High | OFF | ON |

ABSOLUTE MAXIMUM RATINGS

(TA = +25°C, unless otherwise specified)

| Parameter | Symbol | Rating | Unit |
|-------------------------------|------------------|-------------------------|------|
| Control Voltage | VC | 6.0 ^{Note 1} | V |
| Input Power | P _{in} | +34.5 ^{Note 2} | dBm |
| Operating Ambient Temperature | T _A | -45 ~ +85 | °C |
| Storage Temperature | T _{stg} | -55 ~ +150 | °C |

- Note**
1. |VC1 - VC2| ≤ 6.0 V
 2. 3.0V ≤ |VC1 - VC2| ≤ 5.0V

RECOMMENDED OPERATING RANGE

(TA = +25°C, unless otherwise specified)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|----------------------------|--------|------|------|------|------|
| Operating Frequency | f | 0.5 | - | 6.0 | GHz |
| Switch Control Voltage (H) | VC(H) | +1.8 | +3.0 | +5.3 | V |
| Switch Control Voltage (L) | VC(L) | -0.2 | 0 | +0.2 | V |

ELECTRICAL CHARACTERISTICS 1

(TA = +25°C, VC(H) = 3.0 V, VC(L) = 0 V, Zo = 50 Ω, DC Block Capacitance = 8 pF, unless otherwise specified)

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
|---|------------------------|--|------|------|------|------|
| Insertion Loss | L _{INS1} | f=0.5 to 2.0 GHz Note 1 | - | 0.30 | 0.50 | dB |
| | L _{INS2} | f=2.0 to 2.5 GHz | - | 0.35 | 0.55 | dB |
| | L _{INS3} | f=2.5 to 3.8.0GHz | - | 0.40 | 0.60 | dB |
| | L _{INS4} | f=3.8 to 6.0GHz | - | 0.45 | 0.70 | dB |
| Isolation | ISL1 | f=0.5 to 2.0 GHz Note 1 | 29 | 32 | - | dB |
| | ISL2 | f=2.0 to 2.5 GHz | 29 | 32 | - | dB |
| | ISL3 | f=2.5 to 3.8.0GHz | 29 | 32 | - | dB |
| | ISL4 | f=3.8 to 6.0GHz | 23 | 26 | - | dB |
| Return Loss | RL1 | f=0.5 to 2.0GHz Note 1 | 15 | 20 | - | dB |
| | RL2 | f=2.0 to 2.5GHz | 15 | 20 | - | dB |
| | RL3 | f=2.5 to 6.0GHz | 10 | 15 | - | dB |
| 0.1dB Loss Compression Input Power Note 2 | P _{in(0.1dB)} | f=0.5 to 2.0GHz Note1 | - | +32 | - | dBm |
| | | f=2.0 to 6.0GHz | - | +31 | - | dBm |
| | | f=0.5 to 6.0GHz Note1 VC(H)=5.0V | - | +35 | - | dBm |
| 0.5dB Loss Compression Input Power Note 3 | P _{in(0.5dB)} | f=0.5 to 2.0GHz Note1 | - | +34 | - | dBm |
| | | f=2.0 to 6.0GHz | - | +34 | - | dBm |
| 2nd Harmonics | 2f ₀ | f=2.5GHz, P _{in} =+20dBm | - | -90 | - | dBc |
| | | f=6.0GHz, P _{in} =+20dBm | - | -90 | - | dBc |
| 3rd Harmonics | 3f ₀ | f=2.5GHz, P _{in} =+20dBm | - | -90 | - | dBc |
| | | f=6.0GHz, P _{in} =+20dBm | - | -90 | - | dBc |
| 3rd Order Input Intercept Point | IIP ₃ | f=2.5GHz, 2-tone 1MHz Spacing | - | 60 | - | dBm |

Note 1. DC block capacitance = 56 pF at f = 0.5 to 2.0 GHz

2. P_{in(0.1dB)} is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

3. P_{in(0.5dB)} is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range

ELECTRICAL CHARACTERISTICS 2

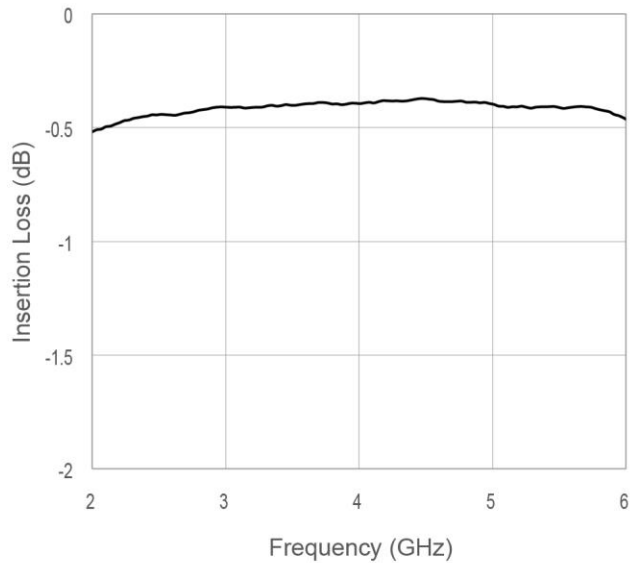
(TA = +25°C, VC(H) = 3.0 V, VC(L) = 0 V, Zo = 50 Ω, DC Block Capacitance = 8 pF, unless otherwise specified)

| | | | | | | |
|------------------------|-------------------|---|---|-----|-----|----|
| Error Vector Magnitude | EVM | 802.11a, 64QAM, 54Mbps, Pin \leq +25dBm | - | 0.5 | - | % |
| | | 802.11g, 64QAM, 54Mbps, Pin \leq +25dBm | - | 0.5 | - | % |
| | | 802.11ac, 256QAM, MCS9, 80MHz, Pin \leq +25dBm | - | 0.5 | - | % |
| Switch Control Current | I _{CONT} | RF none | - | 2 | 10 | uA |
| Switching Speed | t _{SW} | 50% CTL to 90/10% RF | - | 100 | 250 | ns |

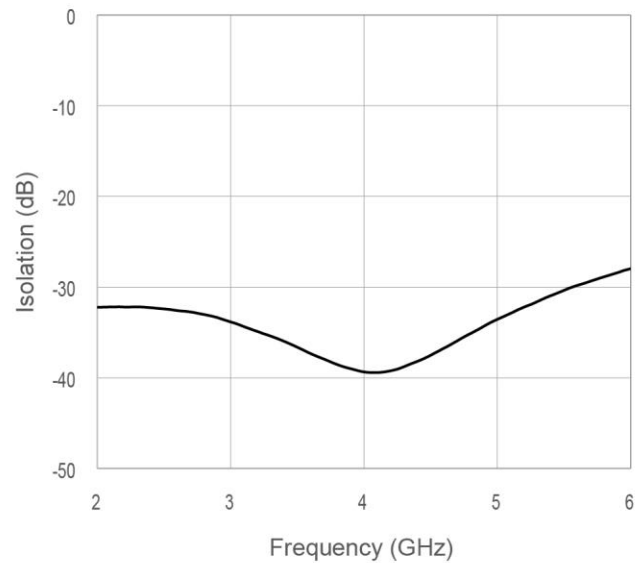
TYPICAL CHARACTERISTICS

(VC(H)=3V, VC(L)=0V, T_A = +25°C, DC Block Capacitance=8pF, through board loss is subtracted in insertion loss data)

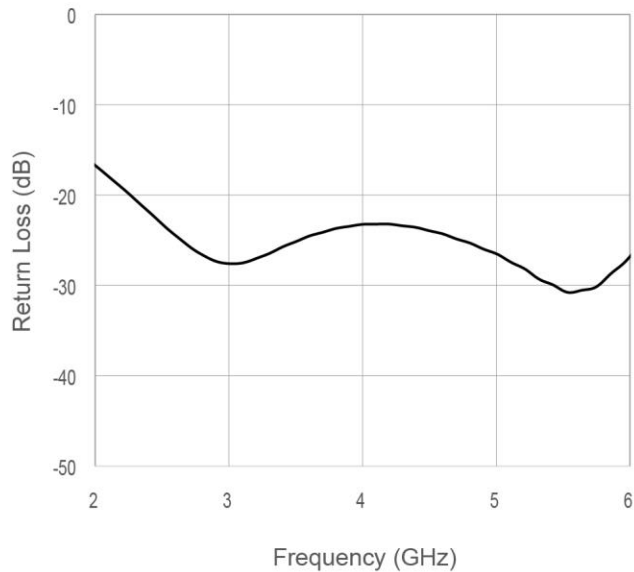
Typical Insertion Loss vs. Frequency



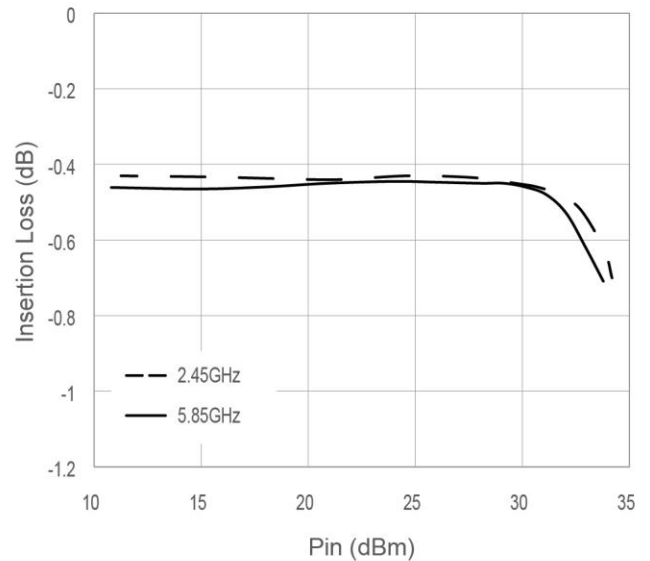
Typical Isolation vs. Frequency



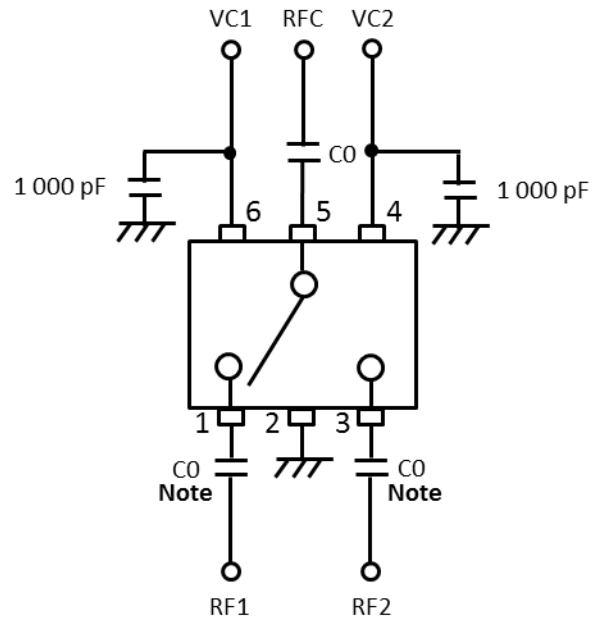
Typical Return Loss vs. Frequency



Typical Insertion Loss vs. Input Power



EVALUATION CIRCUIT

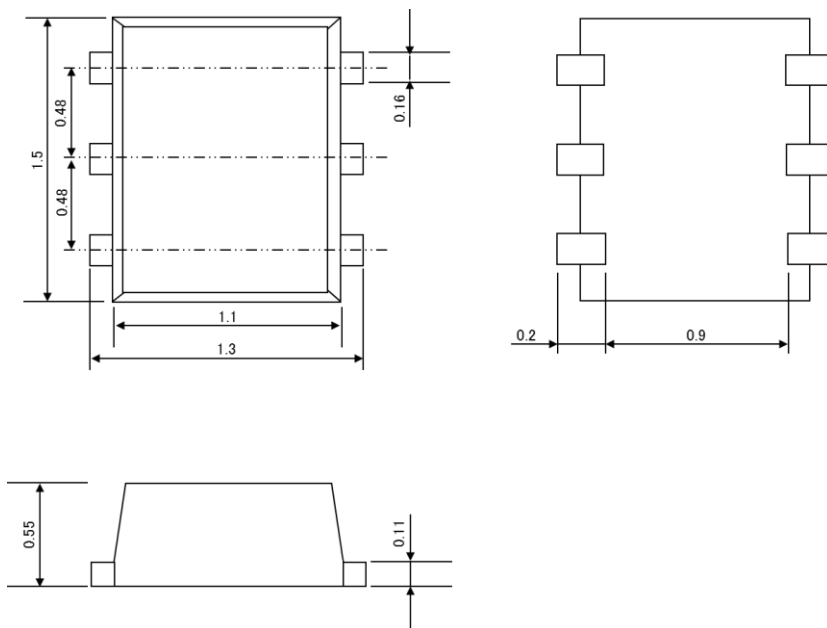


Note C0 : 0.5 to 2.0 GHz 56pF
: 2.0 to 6.0 GHz 8pF

The application circuits and their parameters are for reference only and are not intended for use in actual designs. DC Blocking Capacitors are required at all RF ports.

PACKAGE DIMENSIONS

6-pin lead-less mini mold package (Unit: mm)



RECOMMENDED SOLDERING CONDITIONS

Recommended Soldering Conditions are available on CEL's [Part Summary page](#) under Associated Documents

REVISION HISTORY

| Version | Change to current version | Page(s) |
|---|---|---------|
| CDS-0022-01 (Issue A) February 17, 2016 | Initial datasheet | N/A |
| CDS-0022-02 (Issue B) March 11, 2016 | Added Eval Board ordering information | 1 |
| CDS-0022-02 (Issue C) March 16, 2016 | Added Package Photo | 1 |
| CDS-0022-02 (Issue D) April 4, 2016 | Updated marking information and MOQ | 1,2 |
| CDS-0022-02 (Issue E) August 11, 2016 | Removed "preliminary" | All |
| CDS-0022-02 (Issue F) January 11, 2017 | Revised Electrical Characteristics table Added "Recommended Soldering Conditions" section | 3, 5 |
| CDS-0022-04 (Issue G) September 15, 2017 | Updated Characteristics tables and added Error Vector Magnitude Added "Typical Characteristics" graphs section | 3, 4, 5 |

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